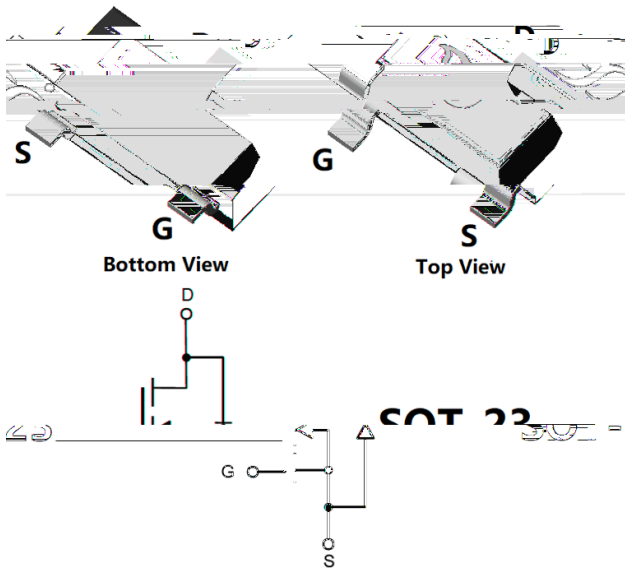




N-Channel Enhancement Mode Field Effect Transistor



Product Summary

V_{DS}	20V
I_D	4.5A
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	25m
$R_{DS(ON)}$ (at $V_{GS}=2.5V$)	32m

General Description

- Trench Power MV MOSFET technology
- High Speed switching
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- PWM application
- Load switch

Absolute Maximum Ratings ($T_A=25$ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-source Voltage	V_{DS}	20	V	
Gate-source Voltage	V_{GS}	± 10	V	
Drain Current	I_D	$T_A=25$	4.5	A
		$T_A=100$	2.8	
Pulsed Drain Current ^A	I_{DM}	30	A	
Total Power Dissipation ^B	P_D	$T_A=25$	1	W
		$T_A=100$	0.4	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 +150		

Thermal resistance

Parameter	Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^C	R_{JA}	100	125	$\text{}/W$

Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJL2300C	F2	2300C.	3000	30000	120000	7" reel



YJL2300C

RECOMMEND YJL2300A FOR NEW DESIGN

Electrical Characteristics (T_J=25 unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V	-	-	1	μA
		V _{DS} =20V, V _{GS} =0V, T _J =150	-	-	100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.4	0.6	1	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =4.5A	-	20	25	m
		V _{GS} =2.5V, I _D =3A	-	25	32	
		V _{GS} =1.8V, I _D =2.7A	-	33	46	
Diode Forward Voltage	V _{SD}	I _S =4.5A, V _{GS} =0V	-	0.9	1.2	V
Gate resistance	R _G	f=1MHz, Open drain	-	2.7	-	
Maximum Body-Diode Continuous Current	I _S		-	-	4.5	A
Dynamic Parameters						
Input Capacitance	C _{iss}		-	390	-	pF
Output Capacitance	C _{oss}	V _{DS} =10V, V _{GS} =0V, f=1MHz	-	75	-	
Reverse Transfer Capacitance	C _{rss}		-	70	-	
Switching Parameters						
Total Gate Charge	Q _g		-	12.5	-	nC
Gate-Source Charge	Q _{gs}	V _{GS} =10V, V _{DS} =10V, I _D =4.5A	-	1	-	
Gate-Drain Charge	Q _{gd}		-	2.5	-	
Reverse Recovery Charge	Q _{rr}		-	3.5	-	nC
Reverse Recovery Time	t _{rr}	I _F =4.5A, di/dt=150A/us	-	10	-	ns
Turn-on Delay Time	t _{D(on)}		-	4.5	-	ns
Turn-on Rise Time	t _r	V _{GS} =10V, V _{DD} =10V, I _D =4.5A R _{GEN} =2.2	-	28	-	
Turn-off Delay Time	t _{D(off)}		-	21	-	
Turn-off fall Time	t _f		-	2.5	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. P_d is based on max. junction temperature, using junction-case thermal resistance.

C. The value of R_{JA} is measured with the device mounted on the minimum recommend pad size, in the still air environment with T_A=25 .

YJL2300C

RECOMMEND
YJL2300A
FOR NEW DESIGN



Figure 5. On-Resistance vs Gate to Source Voltage

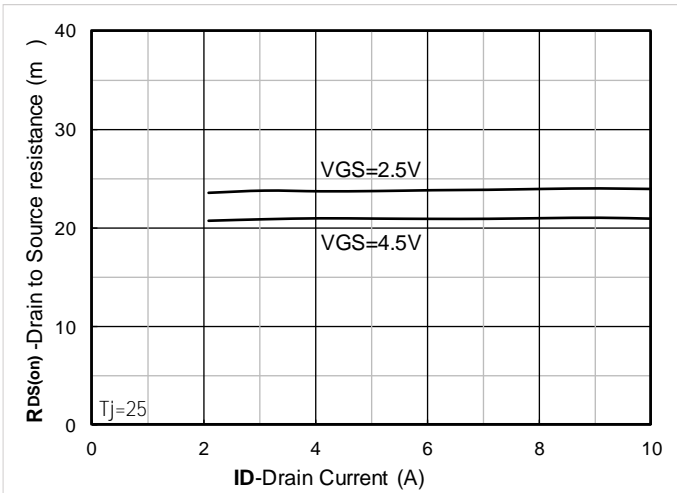


Figure 7. $R_{DS(on)}$ VS Drain Current

Figure 6. Normalized On-Resistance

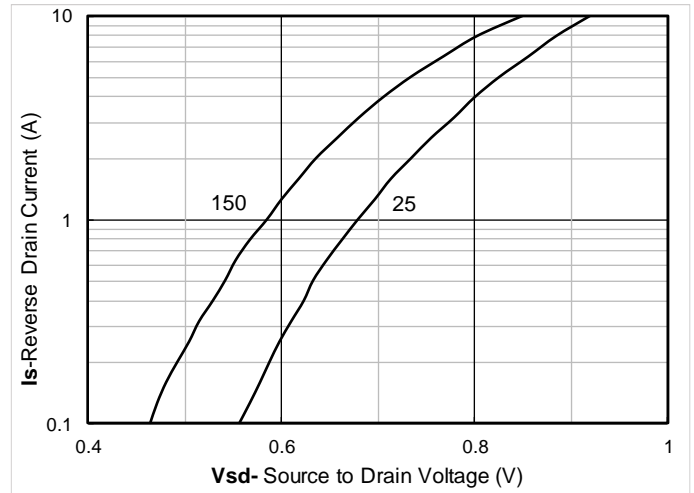


Figure 8. Forward characteristics of reverse diode

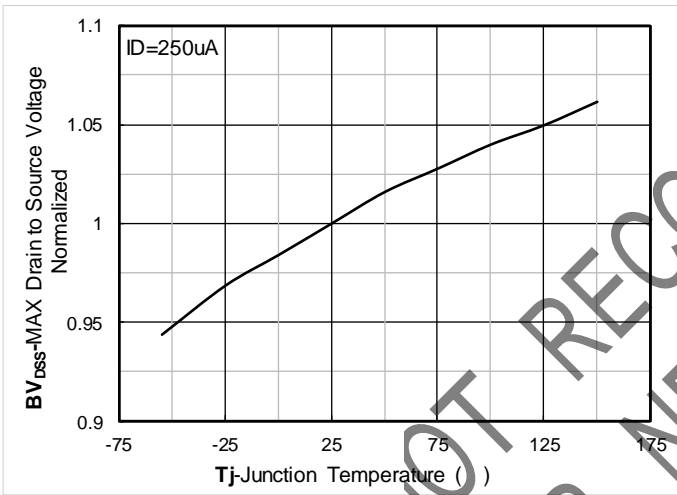


Figure 9. Normalized breakdown voltage

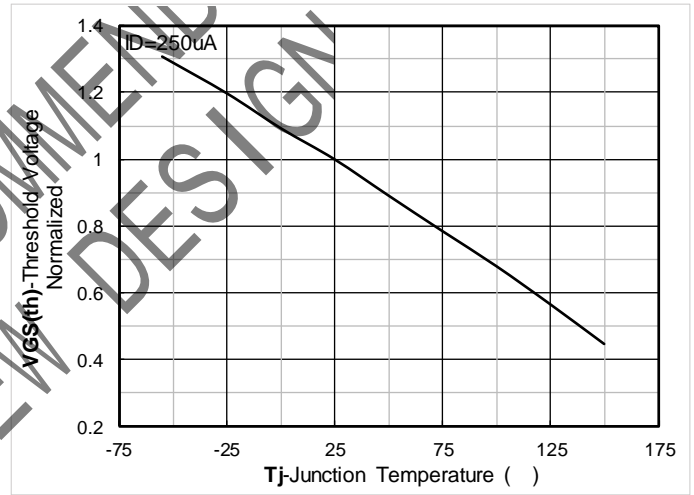


Figure 10. Normalized Threshold voltage

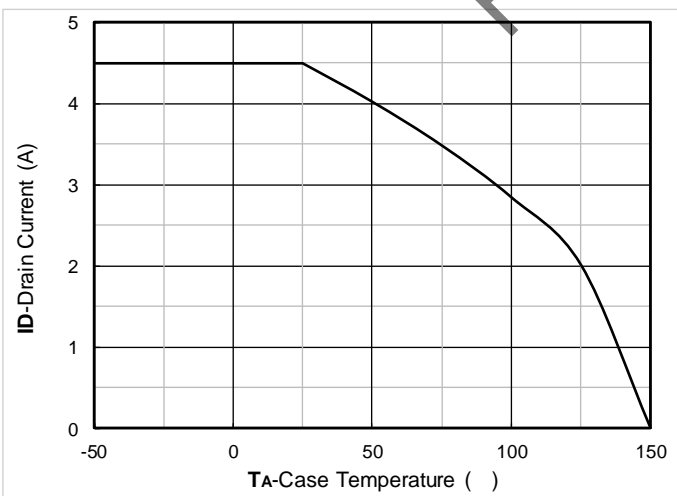


Figure 11. Current dissipation

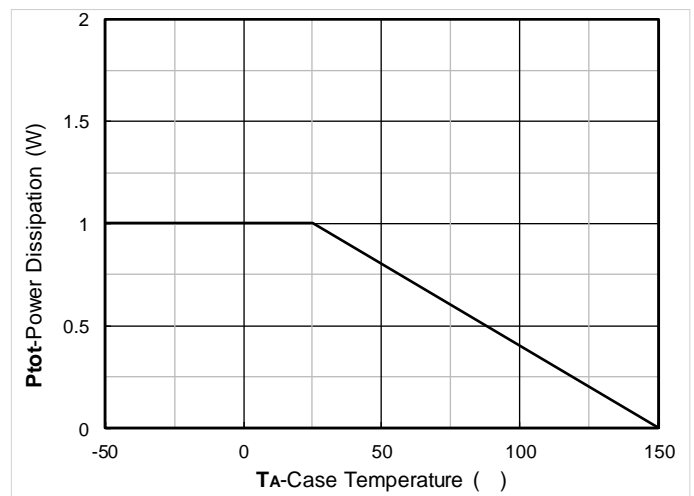
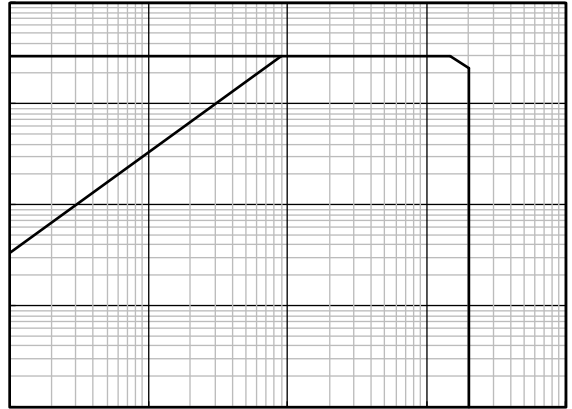


Figure 12. Power dissipation



D05

Figure 13. Maximum Transient Thermal Impedance

Figure 14. Safe Operation Area

Test Circuits & Waveforms

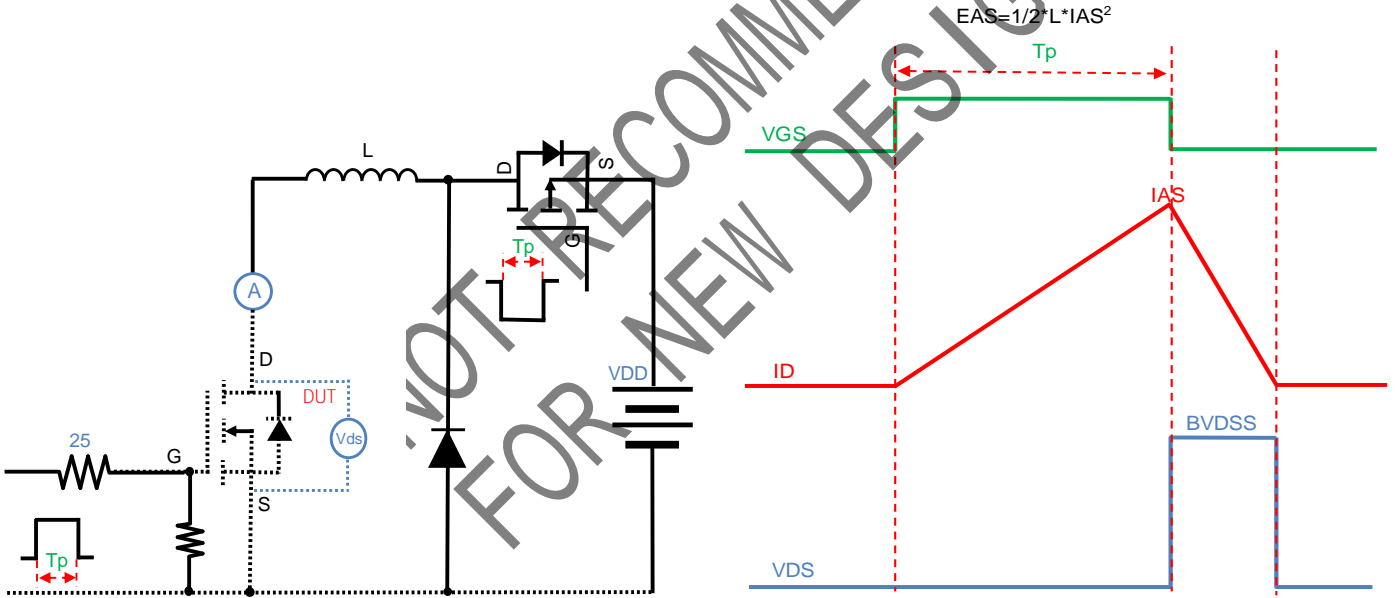


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

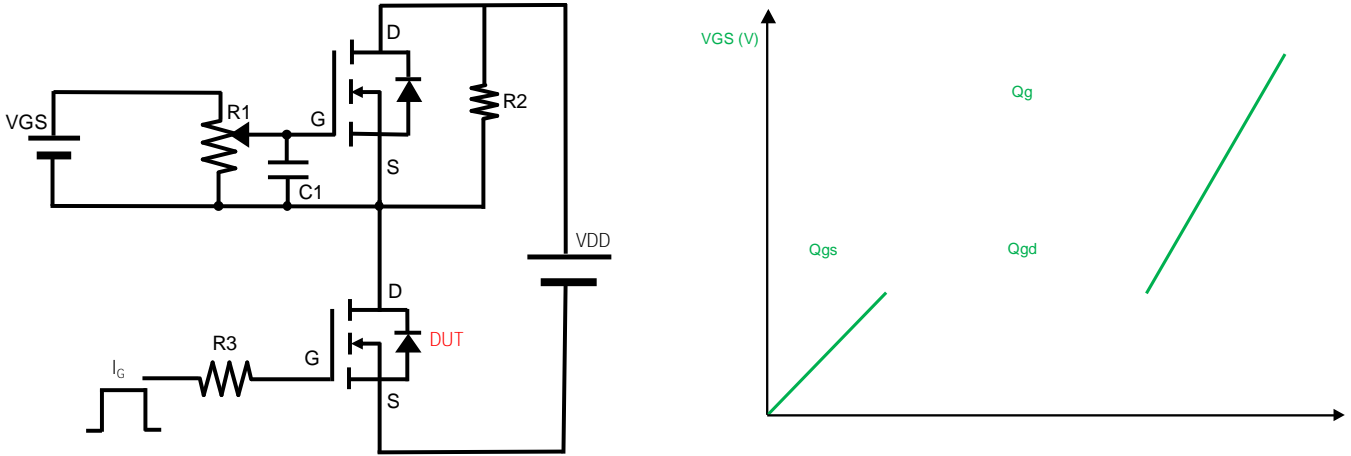


Figure B. Gate Charge Test Circuit & Waveform

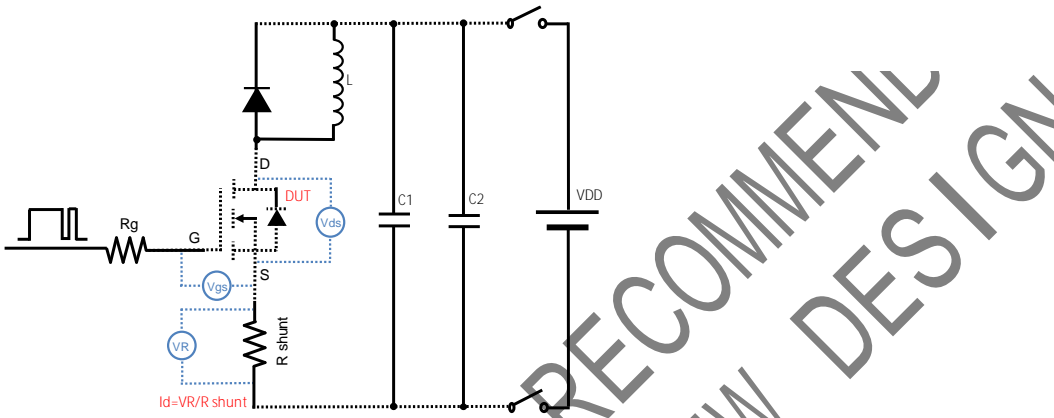


Figure C. Resistive Switching Test Circuit & Waveform

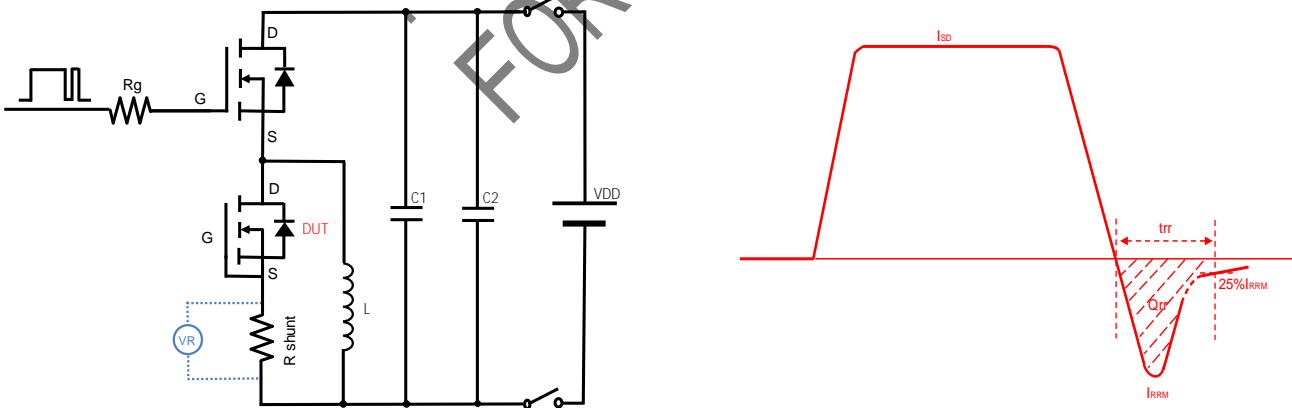


Figure D. Diode Recovery Test Circuit & Waveform



SOT-23 Package information



UNIT: mm

NOT RECOMMENDED
FOR NEW DESIGN



Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website <http://www.21yangjie.com> , or consult your nearest Yangjie's sales office for further assistance.

NOT RECOMMEND
FOR NEW DESIGN